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JCS83 U.S. PTO

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Docket No: M10-25447

**PATENT APPLICATION TRANSMITTAL UNDER 37 C.F.R. 1.53**

**Box Patent Application**  
**Assistant Commissioner for Patents**  
**Washington, D.C. 20231**

JCS84 U.S. PTO  
09/437418  
11/10/99

Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): Said Karbassi and D. Joseph Maurer

Title: SENSOR PACKAGE

**1. Type of Application**

- ☒ This is a new application for a
- ☒ utility patent.
  - ☐ design patent.
- ☐ This is a continuation-in-part application of prior application no.

**2. Application Papers Enclosed**

- 1 Title Page
- 6 Pages of Specification (excluding Claims, Abstract & Drawings)
- 5 Page(s) of Claims
- 1 Page(s) of Abstract
- 4 Sheet(s) of Drawings (Figs. 1 to 8)
  - ☐ Formal
  - ☒ Informal

**CERTIFICATION UNDER 37 CFR 1.10**

I hereby certify that this Patent Application Transmittal and the documents referred to as enclosed therewith are being deposited with the United States Postal Service on **November 10, 1999**, in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 utilizing the "Express Mail Post Office to Addressee" service of the United States Postal Service under Mailing Label No. EL402772808US.

  
RICHARD ZIMMERMANN

**3. Declaration or Oath**

- ☐ Enclosed
  - ☐ Executed by (check all applicable boxes)
    - ☐ Inventor(s)
    - ☐ Legal representative of inventor(s)  
(37 CFR 1.42 or 1.43)
    - ☐ Joint inventor or person showing a proprietary interest on behalf  
of inventor who refused to sign or cannot be reached
      - ☐ The petition required by 37 CFR 1.47 and the statement  
required by 37 CFR 1.47 are enclosed. See Item 5D below  
for fee.
- ☒ Not enclosed - the undersigned attorney or agent is authorized to file this  
application on behalf of the applicant(s). An executed declaration will follow.

**4. Additional Papers Enclosed**

- ☐ Preliminary Amendment
- ☐ Information Disclosure Statement
- ☐ Declaration of Biological Deposit
- ☐ Computer readable copy of sequence listing containing nucleotide and/or  
amino acid sequence
- ☐ Microfiche computer program
- ☐ Verified statement(s) claiming small entity status under 37 CFR 1.9 and 1.27
- ☐ Power of Attorney
- ☐ Verified translation of a non-English patent application
- ☐ An assignment of the invention
- ☒ Return receipt postcard
- ☐ Other

03437418-11039  
650111-8142460

**5. Priority Applications Under 35 USC 119**

Certified copies of applications from which priority under 35 USC 119 is claimed are listed below and

- ☐ are attached.
- ☐ will follow.

COUNTRY	APPLICATION NO.	FILED

**6. Filing Fee Calculation (37 CFR 1.16)**

**A. ☒ Utility Application**

CLAIMS AS FILED - INCLUDING PRELIMINARY AMENDMENT (IF ANY)						
			SMALL ENTITY		OTHER THAN A SMALL ENTITY	
	NO. FILED	NO. EXTRA	RATE	FEE	RATE	FEE
BASIC FEE				\$380.00		\$760.00
TOTAL	29 -20	= 9	X 9 =	\$	X 18 =	\$162.00
INDEP.	3 - 3	= 0	X 39 =	\$	X 78 =	\$ 0
<input type="checkbox"/> First Presentation of Multiple Dependent Claim			+ 130 =	\$	+ 260 =	\$ 0
Filing Fee:				\$	<b>OR</b>	\$922.00

**B. ☐ Design Application (\$155.00/\$310.00)** Filing Fee: \$ \_\_\_\_\_

**C. ☐ Plant Application (\$240.00/\$480.00)** Filing Fee: \$ \_\_\_\_\_

**D. Other Fees**

☐ Recording Assignment [Fee -- \$40.00 per assignment] \$ 0

☐ Petition fee for filing by other than all the inventors  
or person on behalf of the inventor where inventor refused  
to sign or cannot be reached [Fee -- \$130.00] \$ \_\_\_\_\_

☐ Other \$ \_\_\_\_\_

**Total Fees Enclosed \$922.00**

56011 374263

**7. Method of Payment of Fees**

- ☐ Enclosed is a check in the amount of: \$ \_\_\_\_\_
- ☒ Charge Deposit Account No. 08-2727 in the amount of: \$922.00  
A copy of this Transmittal is enclosed.
- ☐ Not enclosed

**8. Deposit Account and Refund Authorization**


The Commissioner is hereby authorized to charge any deficiency in the amount enclosed or any additional fees which may be required during the pendency of this application under 37 CFR 1.16 or 37 CFR 1.17 or under other applicable rules (except payment of issue fees), to Deposit Account No. 08-2727. A copy of this Transmittal is enclosed.

Please refund any overpayment and direct all future communications to Kris T. Fredrick, at Honeywell Inc., Honeywell Plaza, 2701 4th Avenue South, MN12-8251, Minneapolis, Minnesota 55408-1792.

Respectfully submitted,

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November 10, 1999

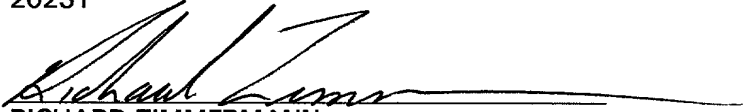
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## JOINT INVENTORS

"EXPRESS MAIL" mailing label No. EL402772808US.

Date of Deposit: **November 10, 1999**

I hereby certify that this paper (or fee) is being deposited with the United States Postal Service "EXPRESS MAIL POST OFFICE TO ADDRESSEE" service under 37 CFR §1.10 on the date indicated above and is addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231

  
RICHARD ZIMMERMANN

## APPLICATION FOR UNITED STATES LETTERS PATENT

# S P E C I F I C A T I O N

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TO ALL WHOM IT MAY CONCERN:

Be it known that we, Said Karbassi, a citizen of the United States, residing at 2626 2nd Avenue, Monroe, 53566, in the County of Green and State of Wisconsin and D. Joseph Maurer, a citizen of the United States, residing at 785 S. Silberman Road, Pearl City, 61062, in the County of Stephenson and State of Illinois have invented a new and useful **SENSOR PACKAGE**, of which the following is a specification.

## SENSOR PACKAGE

### Technical Field of the Invention

The present invention relates to a package for the support of a sensor such as a solid state force sensor.

### 5 Background of the Invention and Prior Art

Typical low cost solid state force sensors mount a sensing element in an external package. The sensing element is attached to an actuator that extends outside of the housing and that communicates an external force to the sensing element within the housing.

10 The actuator in this type of construction can negatively affect the performance and accuracy of the sensor. For example, the construction tolerances of the sensor, of the sensor mounting system, and of the actuator can result in the actuator having an improper position with respect to the sensing element. Improper positioning of the actuator can in turn lead to sensing errors.

15 The present invention eliminates the need for an actuator by providing a sensor package that mounts the sensing element in a planar orientation so that the sensing element can interact directly with the force that it is intended to sense. This mounting arrangement, therefore, eliminates the performance errors and sensitivity loss associated with the sensors that use some form of actuator interface between the sensing  
20 element and the force that is sensed.

Also, the sensing element of the present invention may have a flat, planar surface so that it can better interface with certain compliant materials such as human skin. Conventional force sensors typically cannot maintain a flat surface across the surface of a force sensor package. Moreover, the sensor package of the present  
25 invention has a simple construction and has few components resulting in a relatively low manufacturing cost, it is relatively simple to automate, and it can be made relatively thin for greater accuracy.

Summary of the Invention

In accordance with one aspect of the present invention, a sensor package comprises a force sensing element and a housing. The force sensing element has an element surface. The housing has a housing surface. The housing is arranged to support the force sensing element so that the element surface and the housing surface are substantially coplanar and so that the element surface of the force sensing element directly senses a force without need of an actuator.

According to another aspect of the present invention, a sensor package comprises a force sensing element and a housing. The force sensing element has an element surface. The housing has a housing surface, a well, and first and second shelves within the well. The first and second shelves of the housing are arranged to support the force sensing element so that the element surface and the housing surface are substantially coplanar and so that the element surface of the force sensing element directly senses a force without need of an actuator.

According to yet another aspect of the present invention, a method of packaging a sensing element having an element surface comprises the following steps: a) applying the sensing element to a housing having a housing surface so that the element surface and the housing surface are substantially coplanar; and, b) attaching the sensing element to the housing.

Brief Description of the Drawings

The features and advantages of the present invention will become more apparent from a detailed consideration of the invention taken in conjunction with the drawings in which:

Figure 1 illustrates a top view of a housing that supports a sensing element in accordance with the present invention;

Figure 2 illustrates a cross sectional side view of the housing of Figure 1;

Figure 3 illustrates a side view of a sensing element supported by the housing of Figures 1 and 2;

Figure 4 illustrates a top view of the sensing element of Figure 3;

Figure 5 illustrates a cross sectional side view of the sensing element and housing forming the sensor package of the present invention; and,

Figures 6-8 illustrate alternative housings.

5      Description of the Preferred Embodiment

As shown in Figures 1 and 2, a sensor package 10 includes a housing 12 that may be fabricated from a suitable plastic and that supports a plurality of terminals such as terminals 14, 16, 18, and 20, although other terminal arrangements can be provided. The terminals 14, 16, 18, and 20 are suitably coupled to  
10      corresponding connection pads 22, 24, 26, and 28 that are exposed in a well 30 formed through an upper surface 32 of the housing 12. Shelves 34 and 36 are formed in the housing 12 on each side of the well 30.

Instead of plastic, the housing 12 may be fabricated from other suitable non-conductive materials such as ceramics. In the case of a ceramic housing, the  
15      ceramic may be stepped and may carry thick film conductors.

A sensing element 40 is shown in Figures 3 and 4 and has an upper surface 42 and connection pads 44, 46, 48, and 50. The connection pads 44, 46, 48, and 50 are shown by dashed lines in Figure 4 because the connection pads 44, 46, 48, and 50 are on a lower surface 52 of the sensing element 40. The connection pads 44,  
20      46, 48, and 50 of the sensing element 40 are arranged in a pattern that matches the pattern of the connection pads 22, 24, 26, and 28 of the housing 12.

The sensing element 40, for example, may be supplied under part number PC 11367 or PC 11497 as a piezo resistive sensing element provided commercially by the assignee of the present invention. These sensing elements are  
25      sensor dies incorporating diaphragms. However, because of the shelves 34 and 36, the sensing element 40 may instead be a slab type sensing element machined or otherwise processed to a thickness which produces the proper response to an input force.

The depth of the shelves 34 and 36 are arranged to match the thickness of the sensing element 40 between its upper surface 42 and its lower surface 52 so that,



as shown in Figure 5, when the sensing element 40 is inserted into the well 30 until the sensing element 40 rests against the shelves 34 and 36, the upper surface 42 of the sensing element 40 and the upper surface 32 of the housing 12 are substantially coplanar. Moreover, the shelves 34 and 36 and the well 30 permit the sensing element to bend.

During assembly of the sensor package 10, a dollop 60 of conductive adhesive is placed on each of the connection pads 22, 24, 26, and 28 of the housing 12, and the sensing element 40 is oriented so that its connection pads 44, 46, 48, and 50 are aligned with, and face, the corresponding connection pads 22, 24, 26, and 28 of the housing 12. The sensing element 40 is then inserted into the well 30 until it rests against the shelves 34 and 36 at which point the connection pads 22, 24, 26, and 28 of the housing 12 are electrically coupled to their corresponding connection pads 44, 46, 48, and 50 of the sensing element 40 by the conductive adhesive which was applied to the connection pads 22, 24, 26, and 28.

Accordingly, the well 30 and the shelves 34 and 36 of the housing 12 serve to provide precise alignment of the sensing element 40. Also, as can be seen from Figure 5, following such assembly, the upper surface 32 of the housing 12 and the upper surface 42 of the sensing element 40 lie in substantially the same plane. The well 30 has a clearance below the shelves 34 and 36 to accommodate the dollops 60 of the conductive adhesive. Accordingly, the well 30 provides the space for the conductive adhesive to expand. The tortuous path provided by the shelves 34 and 36 help prevent the conductive adhesive from working around the edge of the sensing element 40 so as to cause sensing element edge electrical shorting. The conductive adhesive provides the electrical connection between the connection pads 22, 24, 26, and 28 of the housing 12 and the corresponding connection pads 44, 46, 48, and 50 of the sensing element 40.

With this arrangement, the housing 12 may be applied so that the sensing element 40 directly senses the force that it is intended to sense without the need of an actuator between the source of this force and the sensing element 40. Also, this arrangement eliminates the need for protrusions and electrical connections on the upper

surfaces 32 and 42 thereby permitting a totally planar surface.

A housing 70 according to an alternative embodiment of the present invention is illustrated in Figure 6. Shelves 72 and 74 are formed in the housing 70 on each side of a well 75, a ledge 76 is formed on the shelf 72, and a ledge 78 is formed on the shelf 74. The shelves 72 and 74 support connection pads 76, 78, 80, and 82 that are suitably coupled to corresponding terminals (not shown). The sensing element 40 is supported by the ledges 76 and 78, and the ledges 76 and 78 are arranged to provide a greater bending moment for the sensing element 40 in order to increase its sensitivity.

A housing 90 according to an another alternative embodiment of the present invention is illustrated in Figure 7. Instead of forming two continuous shelves as previously described, the housing 90 is formed with multiple shelves such as mesas 92, 94, 96, and 98. Connection pads 100, 102, 104, and 106 are provided and are suitably coupled to corresponding terminals (not shown). The sensing element 40 is supported by the mesas 92, 94, 96, and 98. These mesas 92, 94, 96, and 98 further increase the sensitivity of the force sensor of the present invention.

A housing 110 according to yet another alternative embodiment of the present invention is illustrated in Figure 8. The housing 110 is formed with individual mesas such as a mesa 112. The mesa 112 is provided with an adhesive reservoir 114 to hold the dollop 60 of conductive adhesive for coupling a connection pad located beneath the mesa 112 to a corresponding connection pad on the sensing element 40. The other mesas may be provided with correspondingly similar adhesive reservoirs. Moreover, like adhesive reservoirs may be provided in the continuous shelves of the housing embodiment shown in Figures 1-5.

Certain modifications of the present invention have been discussed above. Other modifications will occur to those practicing in the art of the present invention. For example, in cases where the sensor package 10 requires electrical isolation and environmental protection, an optional membrane 62 shown in Figure 5 may be added to the planar surface formed by the upper surface 32 of the housing 12 and by the upper surface 42 of the sensing element 40.

Moreover, the force sensor of the present invention can be used to sense any type of force such as stress.

Furthermore, instead of using the dollop 60 of conductive adhesive in order to couple a connection pad of a terminal to a corresponding connection pad on the sensing element, conductive tape could instead be used.

Additionally, as described above, the thickness of a sensing element and the depth of a shelf or mesa of a housing are controlled so that, when the sensing element is mounted to the housing, the upper surface of the sensing element and the upper surface of the housing are substantially coplanar. This construction permits the thickness of the sensing element to be controlled with respect to the depth of the shelf or mesa of the housing so that, when the sensing element is mounted to the housing, the upper surface of the sensing element protrudes somewhat above the upper surface of the housing, or so that the upper surface of the sensing element is somewhat depressed with respect to the upper surface of the housing.

Accordingly, the description of the present invention is to be construed as illustrative only and is for the purpose of teaching those skilled in the art the best mode of carrying out the invention. The details may be varied substantially without departing from the spirit of the invention, and the exclusive use of all modifications which are within the scope of the appended claims is reserved.

WHAT IS CLAIMED IS:

1                     1. A sensor package comprising:  
2                     a force sensing element having an element surface; and,  
3                     a housing having a housing surface, wherein the housing is arranged to  
4                     support the force sensing element so that the element surface and the housing surface  
5                     are substantially coplanar and so that the element surface of the force sensing element  
6                     directly senses a force without need of an actuator.

1                     2. The sensor package of claim 1 wherein the sensing element has a  
2                     thickness, wherein the housing includes a well and a shelf, wherein the shelf supports  
3                     the sensing element within the well, and wherein the shelf has a depth with respect to  
4                     the thickness of the sensing element such that element surface protrudes above the  
5                     housing surface.

1                     3. The sensor package of claim 1 wherein the sensing element has a  
2                     thickness, wherein the housing includes a well and a shelf, wherein the shelf supports  
3                     the sensing element within the well, and wherein the shelf has a depth with respect to  
4                     the thickness of the sensing element such that element surface is depressed with respect  
5                     to the housing surface.

1                     4. The sensor package of claim 1 wherein the sensing element has a  
2                     thickness, wherein the housing includes a well and a shelf, wherein the shelf supports  
3                     the sensing element within the well, and wherein the shelf has a depth substantially  
4                     matching the thickness of the sensing element.

1                     5. The sensor package of claim 4 wherein the housing has a connection  
2                     pad within the well, wherein the sensing element has a connection pad, and wherein  
3                     the connection pads of the housing and the sensing element are electrically coupled  
4                     together when the sensing element is supported by the shelf of the housing.

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1                   6. The sensor package of claim 5 wherein a conductive adhesive  
2 electrically couples the connection pads of the housing and the sensing element.

1                   7. The sensor package of claim 6 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 electrical isolation of the sensor package.

1                   8. The sensor package of claim 6 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 environmental protection for the sensor package.

1                   9. The sensor package of claim 6 wherein the shelf has an adhesive  
2 reservoir to hold the conductive adhesive.

1                   10. The sensor package of claim 5 wherein the shelf is arranged to  
2 prevent the conductive adhesive from migrating around an edge of the sensing element  
3 and causing sensing element edge electrical shorting.

1                   11. The sensor package of claim 1 wherein the housing has a  
2 connection pad, wherein the sensing element has a connection pad, and wherein the  
3 connection pads of the housing and the sensing element are electrically coupled together  
4 when the sensing element is supported by the housing.

1                   12. The sensor package of claim 11 wherein a conductive adhesive  
2 electrically couples the connection pads of the housing and the sensing element.

1                   13. The sensor package of claim 12 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 electrical isolation of the sensor package.

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1 14. The sensor package of claim 12 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 environmental protection for the sensor package.

1 15. The sensor package of claim 12 wherein the conductive adhesive  
2 is held in an adhesive reservoir of the housing.

1 16. The sensor package of claim 1 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 electrical isolation of the sensor package.

1 17. The sensor package of claim 1 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 environmental protection for the sensor package.

1 18. A sensor package comprising:  
2 a force sensing element having an element surface; and,  
3 a housing having a housing surface, a well, and first and second shelves  
4 within the well, wherein the first and second shelves of the housing are arranged to  
5 support the force sensing element so that the element surface and the housing surface  
6 are substantially coplanar and so that the element surface of the force sensing element  
7 directly senses a force without need of an actuator.

1 19. The sensor package of claim 18 wherein the housing has a  
2 connection pad within the well, wherein the sensing element has a connection pad, and  
3 wherein the connection pads of the housing and the sensing element are electrically  
4 coupled together when the sensing element is supported by the first and second shelves  
5 of the housing.

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1                   20. The sensor package of claim 19 wherein a conductive adhesive  
2 electrically couples the connection pads of the housing and the sensing element.

1                   21. The sensor package of claim 20 wherein the first and second shelves  
2 are arranged to prevent the conductive adhesive from migrating around an edge of the  
3 sensing element and causing sensing element edge electrical shorting.

1                   22. The sensor package of claim 20 wherein the first and second  
2 shelves each has an adhesive reservoir to hold the conductive adhesive.

1                   23. The sensor package of claim 16 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 electrical isolation of the sensor package.

1                   24. The sensor package of claim 16 further comprising a membrane  
2 covering the surfaces of the housing and the sensing element in order to provide  
3 environmental protection for the sensor package.

1                   25. A method of packaging a force sensing element having an element  
2 surface comprising the following steps:

3                   a) applying the force sensing element to a housing having a housing  
4 surface so that the element surface and the housing surface are substantially coplanar;  
5 and,

6                   b) attaching the force sensing element to the housing.

1                   26. The method of claim 25 wherein the force sensing element has a  
2 thickness, wherein the housing includes a well and a shelf, wherein the shelf has a  
3 depth substantially matching the thickness of the force sensing element, and wherein  
4 step a) comprises the step of applying the force sensing element to the housing so that  
5 the shelf supports the force sensing element within the well.

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1                   27. The method of claim 25 wherein the housing has a connection pad,  
2 wherein the force sensing element has a connection pad, and wherein step b) comprises  
3 the step of adhesively binding the connection pads of the housing and the force sensing  
4 element together so that the force sensing element is attached to the housing and so that  
5 the connection pads of the housing and the force sensing element are electrically  
6 coupled together.

1                   28. The method of claim 25 further comprising the step of covering  
2 the surfaces of the housing and the force sensing element with a membrane in order to  
3 provide electrical isolation of the force sensing element.

1                   29. The method of claim 25 further comprising the step of covering  
2 the surfaces of the housing and the sensing element with a membrane in order to  
3 provide environmental protection for the force sensing element.

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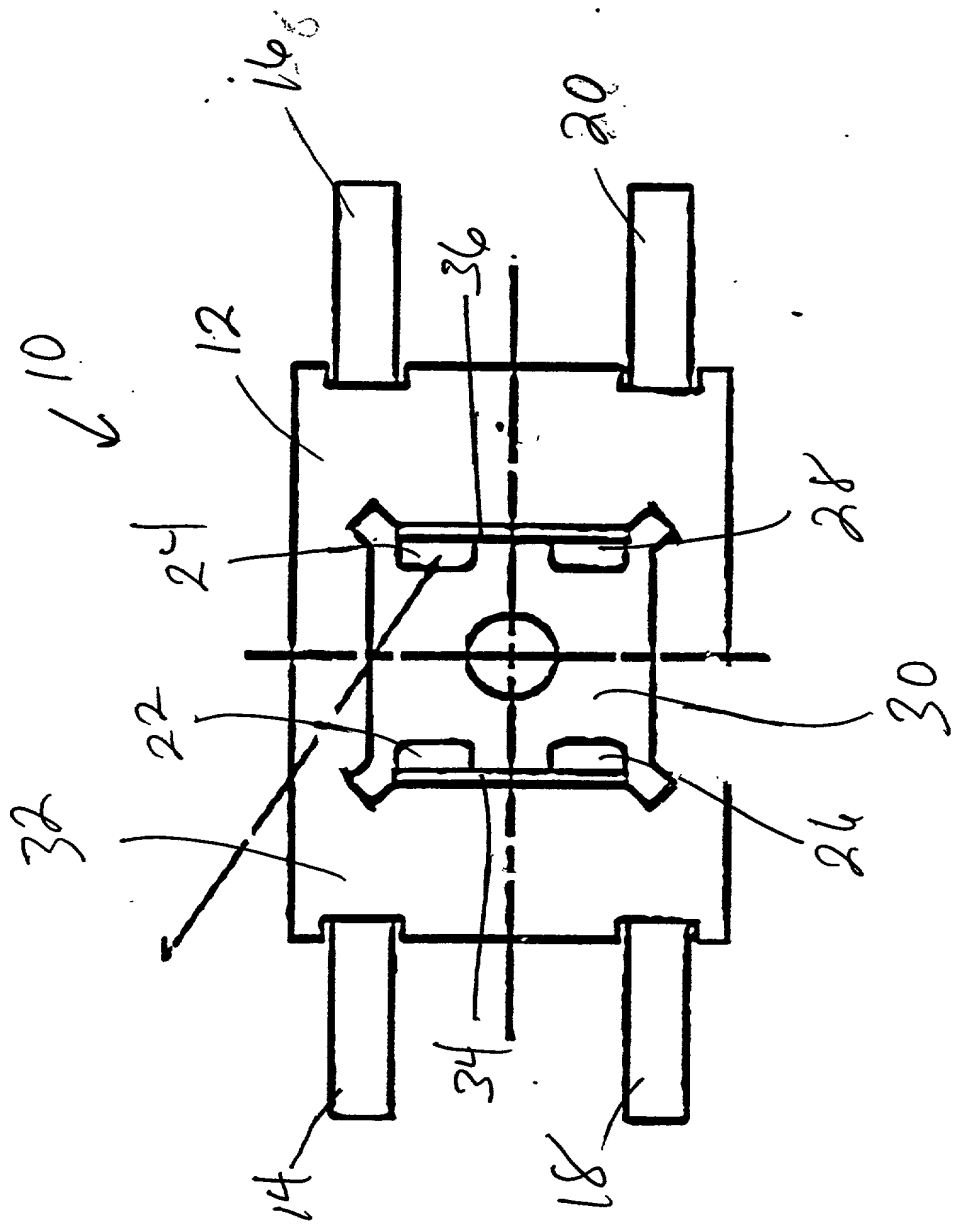


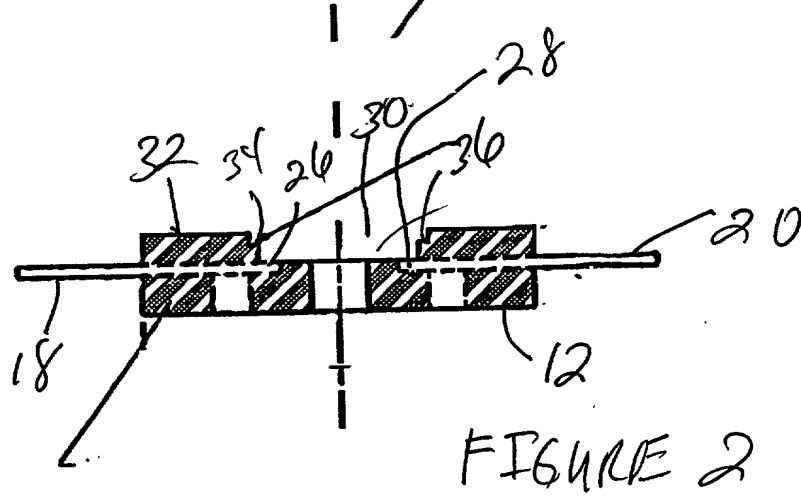
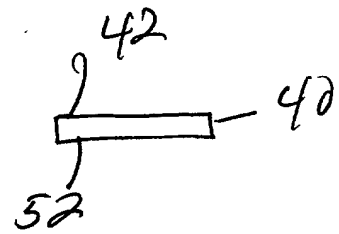
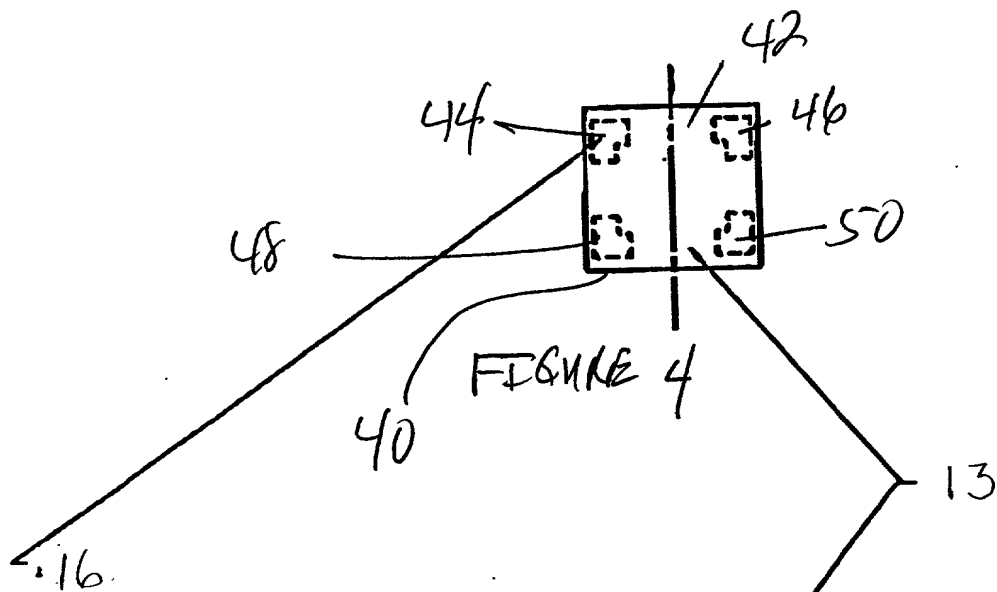
**ABSTRACT OF THE DISCLOSURE**

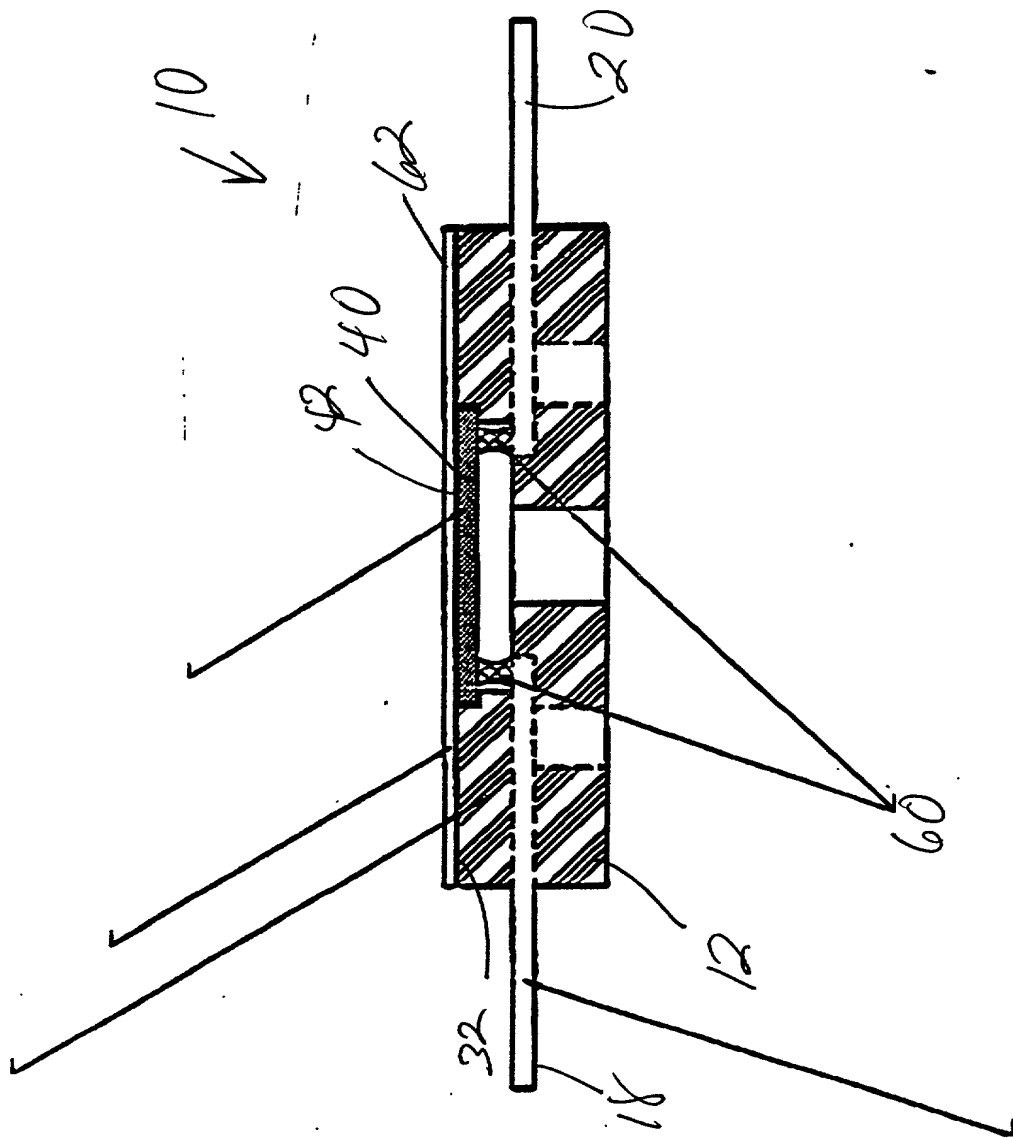
A sensor package includes a force sensing element and a housing. The force sensing element has an element surface, a well, and first and second shelves within the well. The housing has a housing surface. The first and second shelves of the housing are arranged to support the force sensing element so that the element surface and the housing surface are substantially coplanar and so that the element surface of the force sensing element directly senses a force without need of an actuator.

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FIGURE 5

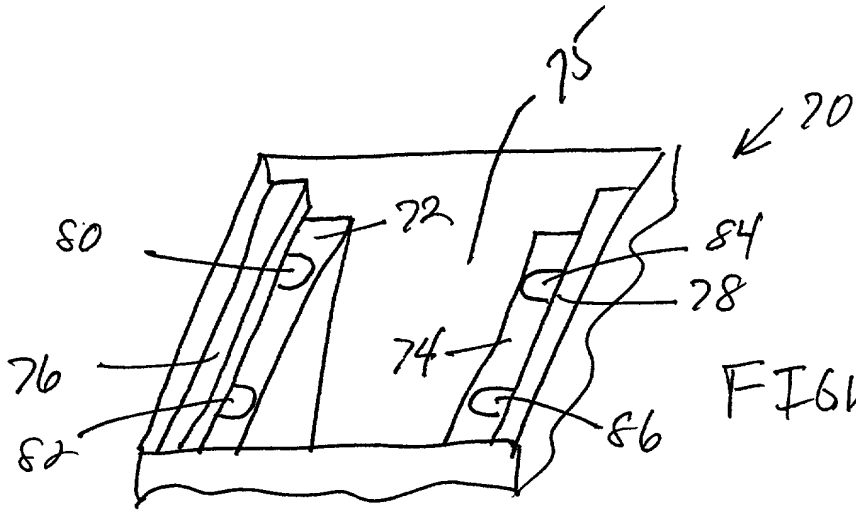


FIGURE 6

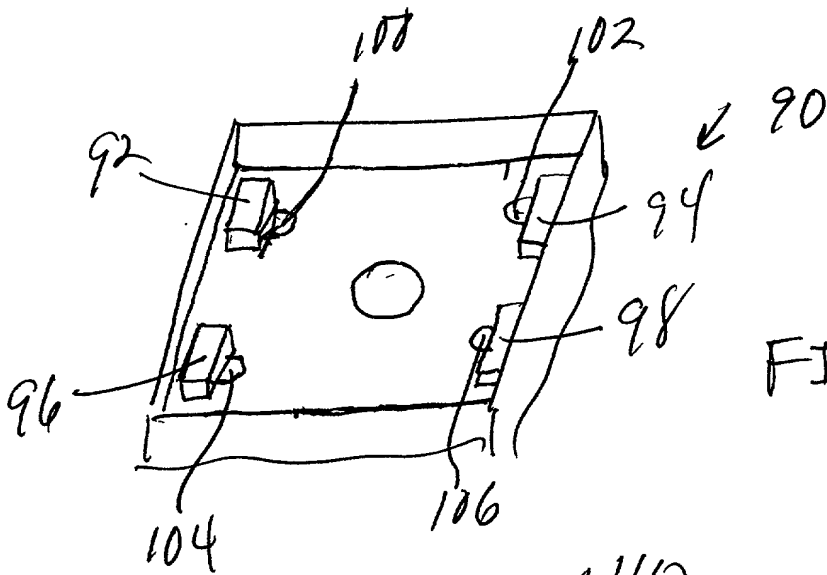


FIGURE 7

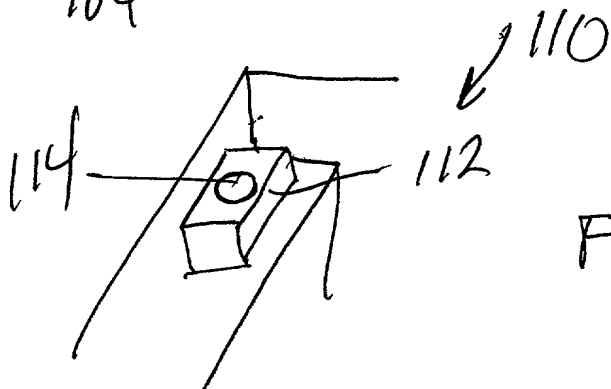


FIGURE 8